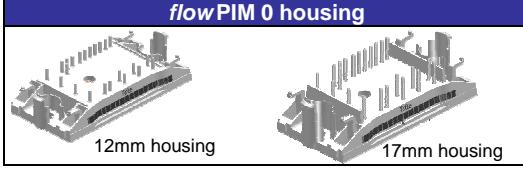
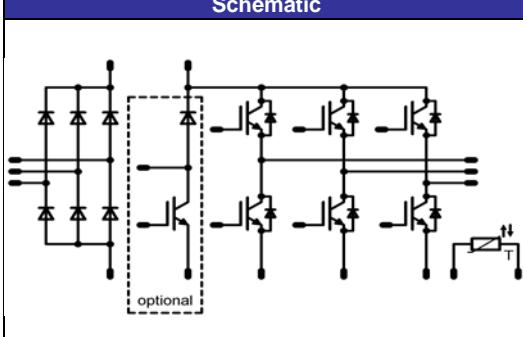


flowPIM 0		600V/10A
<b>Features</b> <ul style="list-style-type: none"> <li>Clip-in housing</li> <li>Trench Fieldstop IGBT's for low saturation losses</li> <li>Optional w/o BRC</li> </ul>		 <p>flowPIM 0 housing 12mm housing      17mm housing</p>
<b>Target Applications</b> <ul style="list-style-type: none"> <li>Industrial drives</li> <li>Embedded drives</li> </ul>		
<b>Types</b> <ul style="list-style-type: none"> <li>V23990-P543-A38-PM</li> <li>V23990-P543-C38-PM w/o BRC</li> <li>V23990-P543-C39-PM w/o BRC</li> </ul>		<b>Schematic</b> 

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

### Input Rectifier Diode

Repetitive peak reverse voltage	$V_{RRM}$		1600	V
DC forward current	$I_{FAV}$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	33 46	A
Surge forward current	$I_{FSM}$	$t_p=10\text{ms}$ $50\text{Hz}$ half sine wave	250	A
$I^2t$ -value	$I^2t$		310	$\text{A}^2\text{s}$
Power dissipation per Diode	$P_{\text{tot}}$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	37 59	W
Maximum Junction Temperature	$T_{j\max}$		150	$^\circ\text{C}$

### Inverter IGBT

Collector-emitter break down voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	16 20	A
Repetitive peak collector current	$I_{Cpulse}$	$t_p$ limited by $T_{j\max}$	30	A
Turn off safe operating area		$V_{CE} \leq 600\text{V}$ , $T_j \leq T_{j\max}$	30	A
Power dissipation per IGBT	$P_{\text{tot}}$	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	39 60	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{sc}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	6 360	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{j\max}$		175	$^\circ\text{C}$

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	$T_j=25^\circ\text{C}$	600	V
<b>Inverter FWD</b>				
DC forward current	$I_F$	$T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	25 25	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_j\text{max}$	20	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	22 32	W
Maximum Junction Temperature	$T_j\text{max}$		175	°C

## Brake IGBT

Collector-emitter break down voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	11 14	A
Repetitive peak collector current	$I_{Cpuls}$	$t_p$ limited by $T_j\text{max}$	18	A
Turn off safe operating area		$V_{CE} \leq 600\text{V}$ , $T_j \leq T_{Top\ max}$	18	A
Power dissipation per IGBT	$P_{tot}$	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	31 47	W
Gate-emitter peak voltage	$V_{GE}$		±20	V
Short circuit ratings	$t_{sc}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	6 360	μs V
Maximum Junction Temperature	$T_j\text{max}$		175	°C

## Brake FWD

Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	10 10	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_j\text{max}$	12	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_j\text{max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	22 34	W
Maximum Junction Temperature	$T_j\text{max}$		175	°C

## Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{op}$		-40...+( $T_{jmax}$ - 25)	°C

## Insulation Properties

Insulation voltage	$V_{is}$	$t=2\text{s}$	DC voltage	4000	V
Creepage distance				min 12,7	mm
Clearance				min 12,7	mm
Comparative tracking index	CTI			>200	

**Characteristic Values**

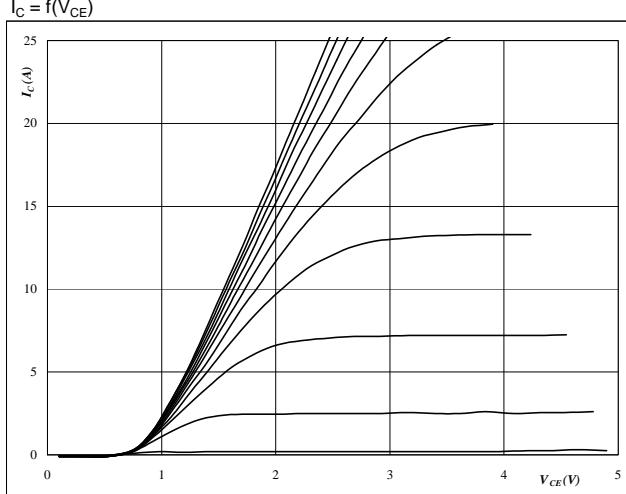
Parameter	Symbol	Conditions				Value			Unit
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max	
<b>Input Rectifier Diode</b>									
Forward voltage	$V_F$			30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	0,8	1,16 1,13	1,6	V
Threshold voltage (for power loss calc. only)	$V_{to}$			30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		0,90 0,78		V
Slope resistance (for power loss calc. only)	$r_t$			30	$T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$		8 11		$\text{m}\Omega$
Reverse current	$I_r$		1500		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			2	$\text{mA}$
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$					1,89		K/W
<b>Inverter IGBT</b>									
Gate emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE}=V_{GE}$		0,00015	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15	10	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1	1,59 1,78	2,2	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	600	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0,08	$\text{mA}$
Gate-emitter leakage current	$I_{GES}$		20	0	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			350	$\text{nA}$
Integrated Gate resistor	$R_{gint}$						none		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=16 \Omega$ $R_{gon}=32 \Omega$	$\pm 15$	300	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		15 14		ns
Rise time	$t_r$						11 14		
Turn-off delay time	$t_{d(off)}$						155 170		
Fall time	$t_f$						89 98		
Turn-on energy loss per pulse	$E_{on}$						0,16 0,22		mWs
Turn-off energy loss per pulse	$E_{off}$						0,24 0,29		
Input capacitance	$C_{ies}$	$f=1\text{MHz}$	$0$	25	$T_j=25^\circ\text{C}$		551		pF
Output capacitance	$C_{oss}$						40		
Reverse transfer capacitance	$C_{rss}$						17		
Gate charge	$Q_{\text{Gate}}$		$\pm 15$	480	10	$T_j=25^\circ\text{C}$	62		$\text{nC}$
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$					2,41		K/W
<b>Inverter FWD</b>									
Diode forward voltage	$V_F$			10	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1	1,61 1,51	2,25	V
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=32 \Omega$	$\pm 15$	300	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		10 11		A
Reverse recovery time	$t_{rr}$						142 219		
Reverse recovered charge	$Q_{rr}$						0,46 0,80		
Peak rate of fall of recovery current	$\frac{di(\text{rec})}{dt}$ max						703 397		
Reverse recovered energy	$E_{rec}$						0,09 0,17		
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50um $\lambda = 1 \text{ W/mK}$					3,33		K/W

**Characteristic Values**

Parameter	Symbol	Conditions				Value			Unit	
		$V_{GE}$ [V] or $V_{GS}$ [V]	$V_T$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max		
<b>Brake IGBT</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,00043	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		6	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1	1,55 1,72	2,1	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	600		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			0,06	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			350	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=16\ \Omega$ $R_{gon}=32\ \Omega$	$\pm 15$	300	6	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		11 10		ns
Rise time	$t_r$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		8 10		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		118 130		
Fall time	$t_f$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		93 117		
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		0,07 0,10		mWs
Turn-off energy loss per pulse	$E_{off}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		0,15 0,18		
Input capacitance	$C_{ies}$	$f=1\text{MHz}$	0	25		$T_j=25^\circ\text{C}$		368		pF
Output capacitance	$C_{oss}$							28		
Reverse transfer capacitance	$C_{rss}$							11		
Gate charge	$Q_{Gate}$					$T_j=25^\circ\text{C}$		42		nC
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50μm $\lambda = 1\text{ W/mK}$						3,07		K/W
<b>Brake FWD</b>										
Diode forward voltage	$V_F$				6	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	1	1,69 1,61	2,5	V
Reverse leakage current	$I_r$	$R_{gon}=32\ \Omega$		600		$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$			60	$\mu\text{A}$
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=32\ \Omega$	$\pm 15$	300	6	$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		7 8		A
Reverse recovery time	$t_{rr}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		97 151		ns
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		0,23 0,23		$\mu\text{C}$
Peak rate of fall of recovery current	$d(i_{rec})/\text{dt}_{\text{max}}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		522 321		$\text{A}/\mu\text{s}$
Reverse recovery energy	$E_{rec}$					$T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		0,05 0,09		mWs
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness≤50μm $\lambda = 1\text{ W/mK}$						4,29		K/W
<b>Thermistor</b>										
Rated resistance	$R$					$T_j=25^\circ\text{C}$		22000		$\Omega$
Deviation of R100	$\Delta R/R$	$R_{100}=1486\ \Omega$				$T_c=100^\circ\text{C}$	-5		5	%
Power dissipation	$P$					$T_c=100^\circ\text{C}$		210		mW
Power dissipation constant						$T_j=25^\circ\text{C}$		3,5		$\text{mW/K}$
B-value	$B_{(25/50)}$	Tol. ±3%				$T_j=25^\circ\text{C}$				K
B-value	$B_{(25/100)}$	Tol. ±3%				$T_j=25^\circ\text{C}$		4000		K
Vincotech NTC Reference						$T_j=25^\circ\text{C}$			A	

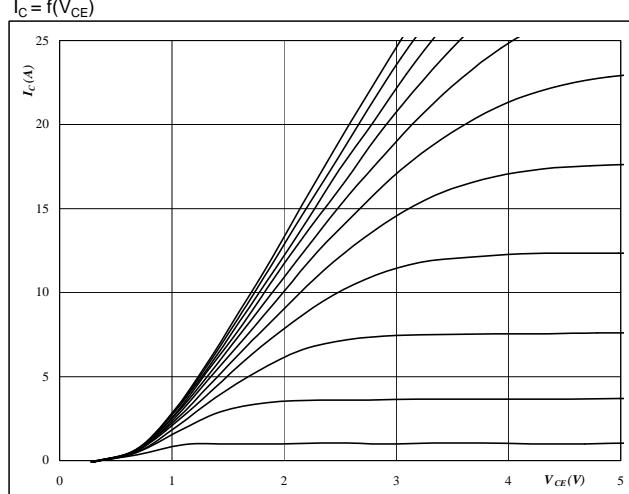
## Output Inverter

**Figure 1**  
Typical output characteristics  
 $I_C = f(V_{CE})$



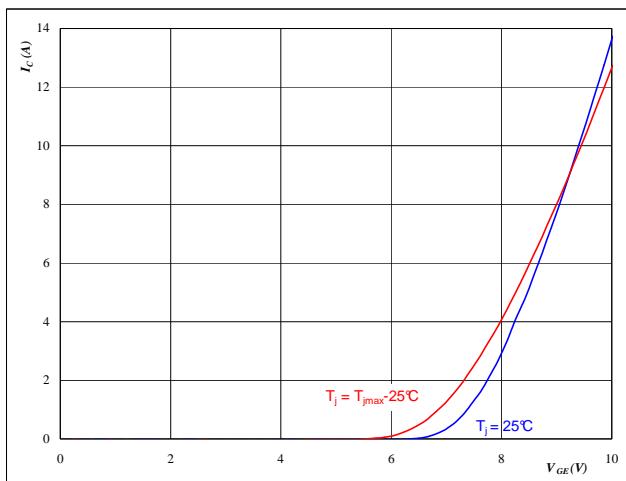
At  
 $t_p = 250 \mu s$   
 $T_j = 25^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 2**  
Typical output characteristics  
 $I_C = f(V_{CE})$



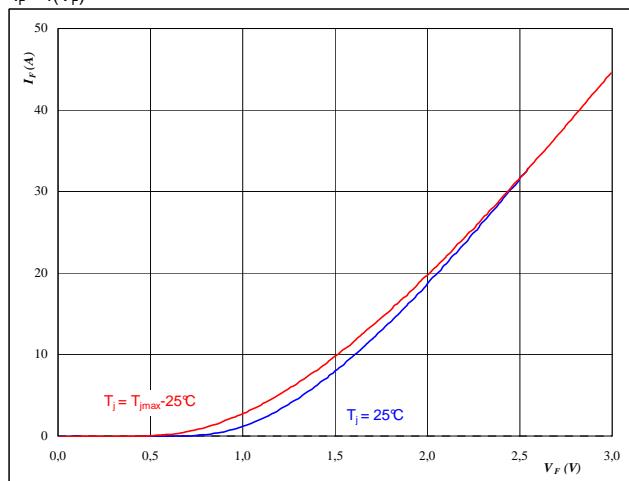
At  
 $t_p = 250 \mu s$   
 $T_j = 125^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3**  
Typical transfer characteristics  
 $I_C = f(V_{GE})$



At  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**Figure 4**  
Typical diode forward current as a function of forward voltage  
 $I_F = f(V_F)$



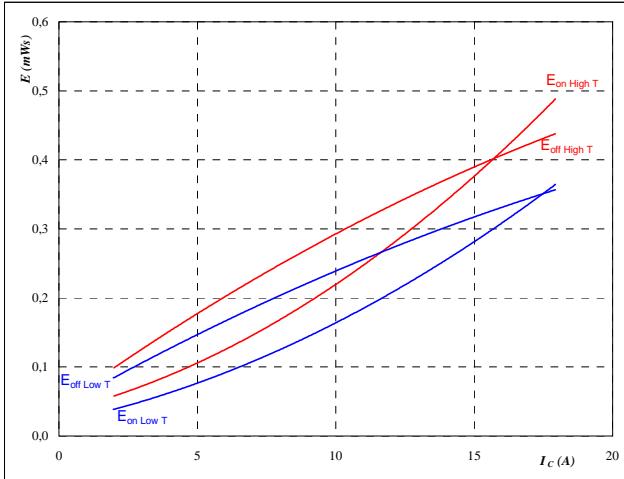
At  
 $t_p = 250 \mu s$

## Output Inverter

**Figure 5**

**Typical switching energy losses  
as a function of collector current**

$$E = f(I_C)$$



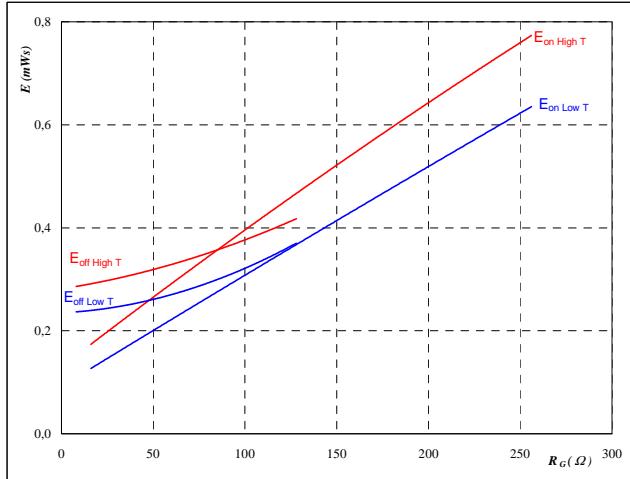
With an inductive load at

$$\begin{aligned} T_j &= \textcolor{red}{25/125} \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \\ R_{goff} &= 16 \quad \Omega \end{aligned}$$

**Output inverter IGBT**
**Figure 6**

**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



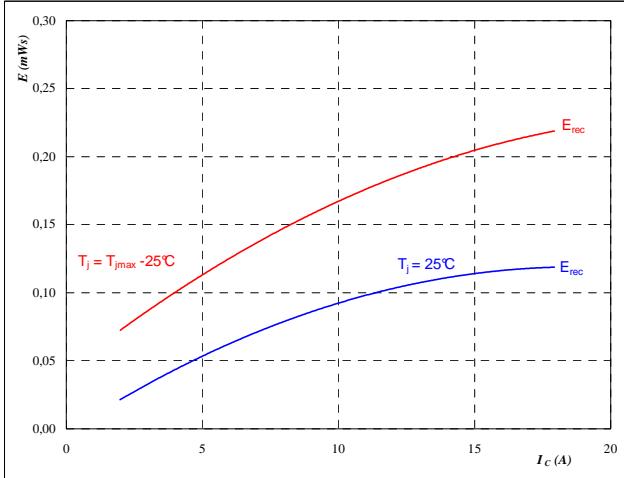
With an inductive load at

$$\begin{aligned} T_j &= \textcolor{red}{25/125} \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= 15 \quad \text{V} \\ I_C &= 10 \quad \text{A} \end{aligned}$$

**Figure 7**
**Output inverter FWD**

**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_C)$$



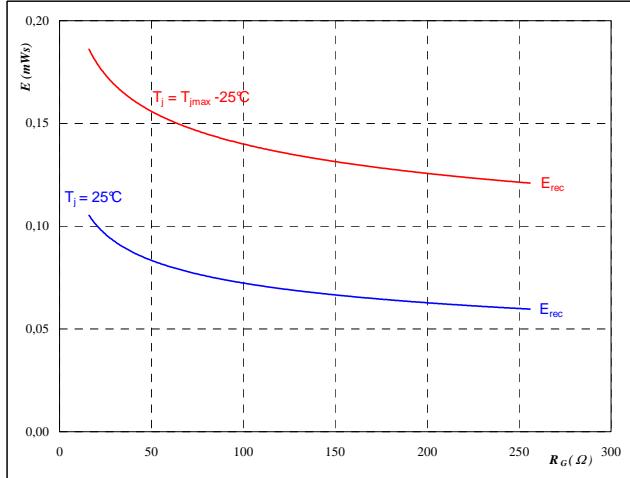
With an inductive load at

$$\begin{aligned} T_j &= \textcolor{red}{25/125} \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \end{aligned}$$

**Figure 8**
**Output inverter FWD**

**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

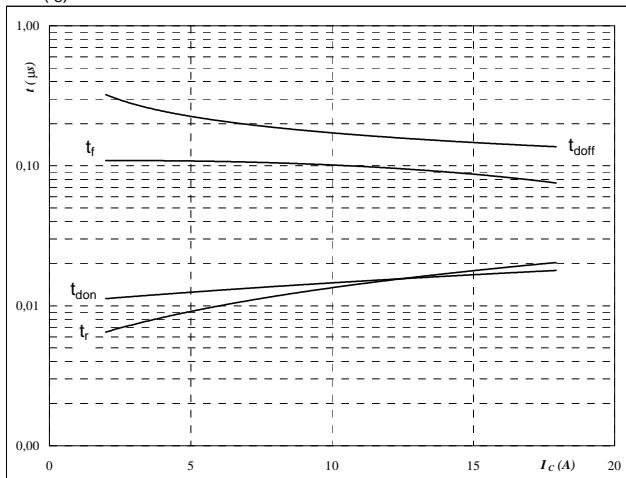
$$\begin{aligned} T_j &= \textcolor{red}{25/125} \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= 15 \quad \text{V} \\ I_C &= 10 \quad \text{A} \end{aligned}$$

## Output Inverter

**Figure 9**

Typical switching times as a function of collector current

$$t = f(I_C)$$



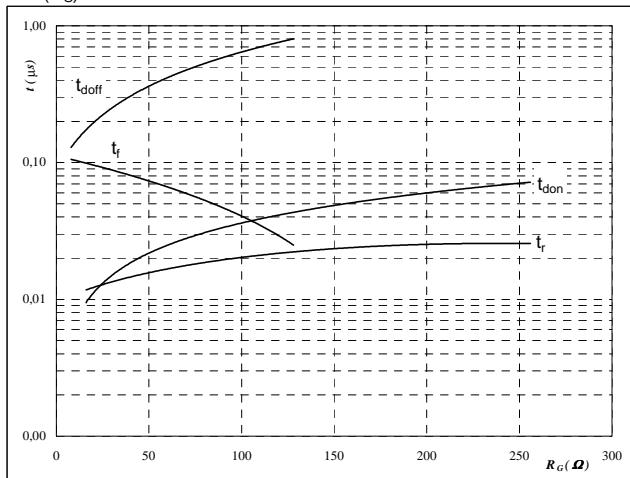
With an inductive load at

$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \\ R_{goff} &= 16 \quad \Omega \end{aligned}$$

**Output inverter IGBT**
**Figure 10**

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



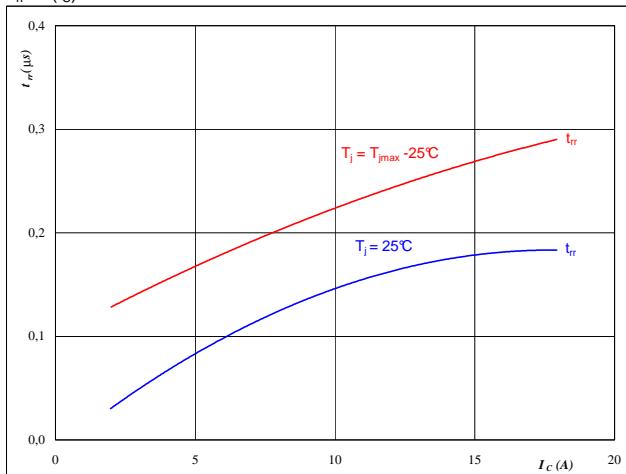
With an inductive load at

$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= 15 \quad \text{V} \\ I_C &= 10 \quad \text{A} \\ R_{gon} &= 32 \quad \Omega \end{aligned}$$

**Figure 11**
**Output inverter FWD**

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



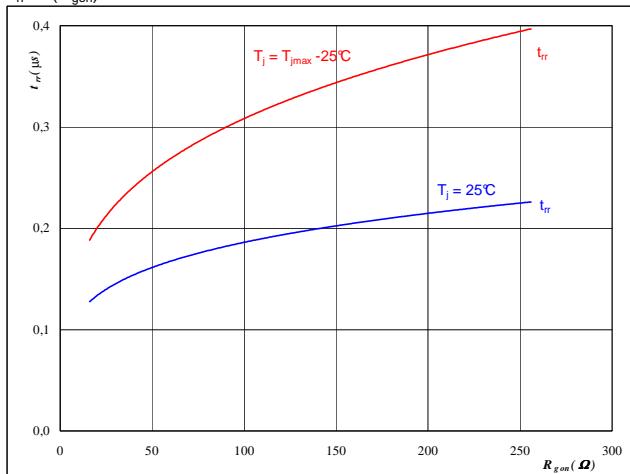
At

$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_{CE} &= 300 \quad \text{V} \\ V_{GE} &= 15 \quad \text{V} \\ R_{gon} &= 32 \quad \Omega \end{aligned}$$

**Output inverter FWD**
**Figure 12**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

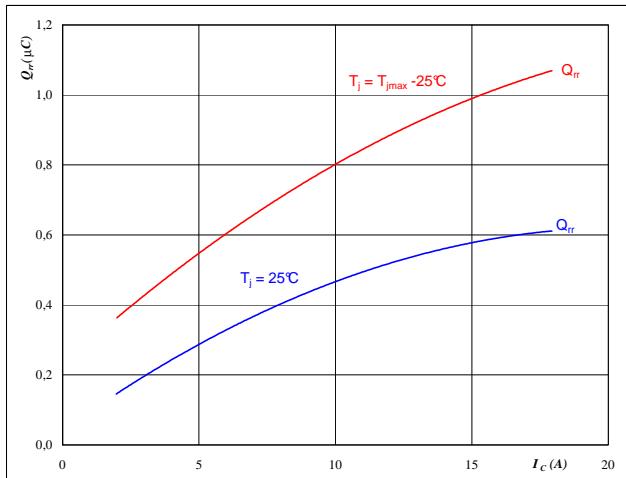
$$\begin{aligned} T_j &= 25/125 \quad ^\circ\text{C} \\ V_R &= 300 \quad \text{V} \\ I_F &= 10 \quad \text{A} \\ V_{GE} &= 15 \quad \text{V} \end{aligned}$$

## Output Inverter

**Figure 13**

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$

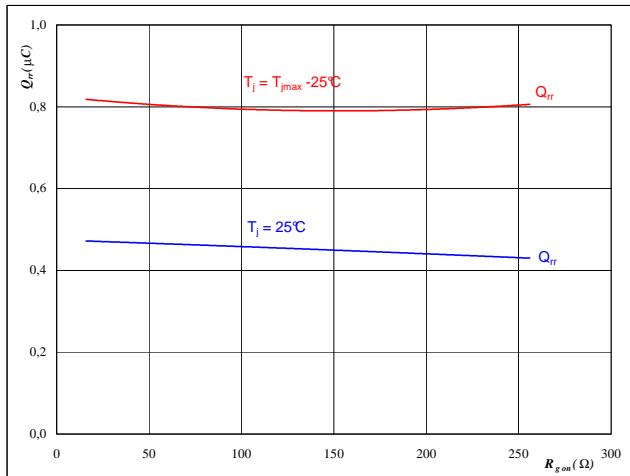

**At**

$T_j =$	<b>25/125</b>	$^\circ\text{C}$
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$R_{gon} =$	32	$\Omega$

**Output inverter FWD**
**Figure 14**

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

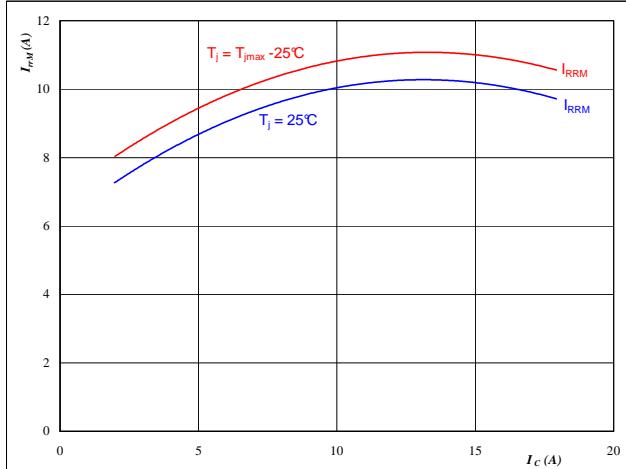

**At**

$T_j =$	<b>25/125</b>	$^\circ\text{C}$
$V_R =$	300	V
$I_F =$	10	A
$V_{GE} =$	15	V

**Figure 15**
**Output inverter FWD**

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$

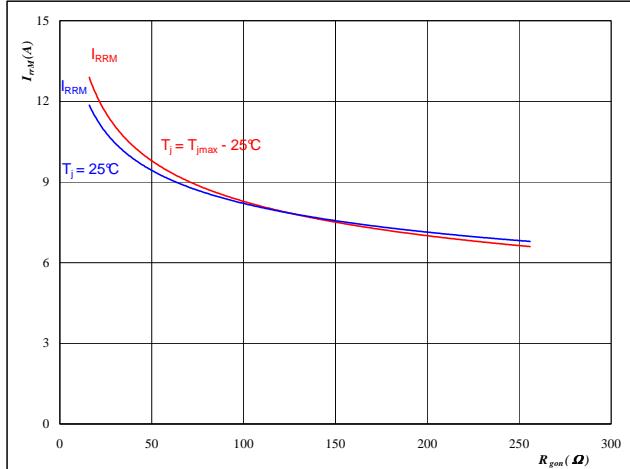

**At**

$T_j =$	<b>25/125</b>	$^\circ\text{C}$
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$R_{gon} =$	32	$\Omega$

**Figure 16**
**Output inverter FWD**

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

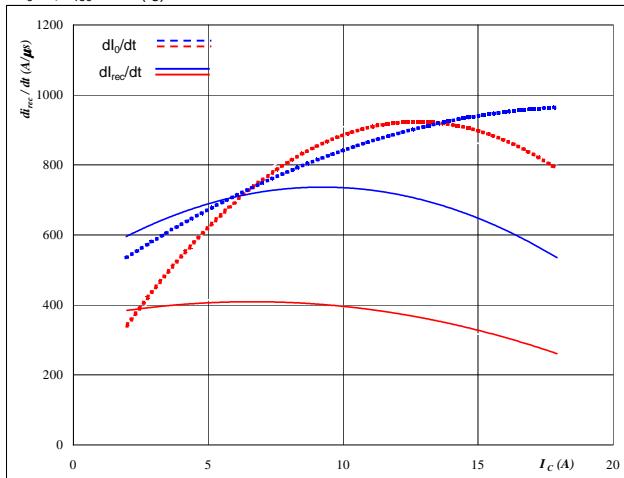

**At**

$T_j =$	<b>25/125</b>	$^\circ\text{C}$
$V_R =$	300	V
$I_F =$	10	A
$V_{GE} =$	15	V

## Output Inverter

**Figure 17**

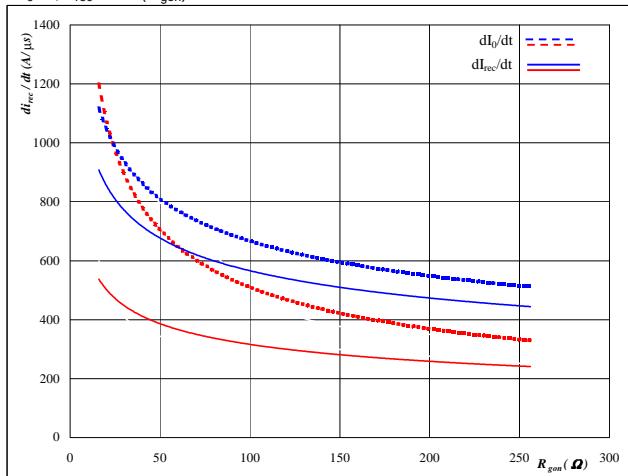
Typical rate of fall of forward  
and reverse recovery current as a  
function of collector current  
 $dI_0/dt, dI_{rec}/dt = f(I_C)$


**At**

$T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $R_{gon} = 32$  Ω

**Output inverter FWD**
**Figure 18**

Typical rate of fall of forward  
and reverse recovery current as a  
function of IGBT turn on gate resistor  
 $dI_0/dt, dI_{rec}/dt = f(R_{gon})$

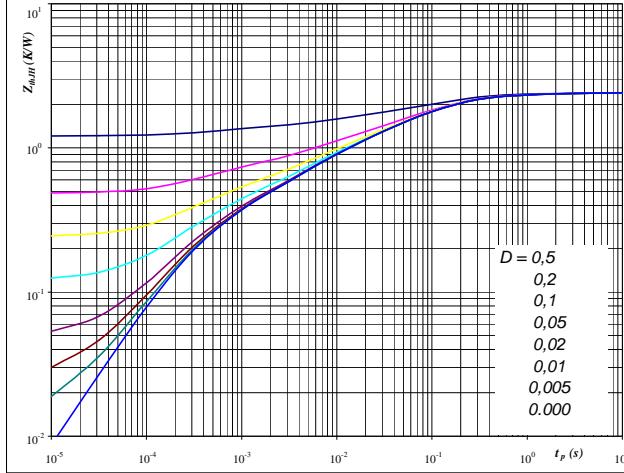

**At**

$T_j = 25/125$  °C  
 $V_R = 300$  V  
 $I_F = 10$  A  
 $V_{GE} = 15$  V

**Figure 19**

IGBT transient thermal impedance  
as a function of pulse width

$$Z_{thJH} = f(t_p)$$

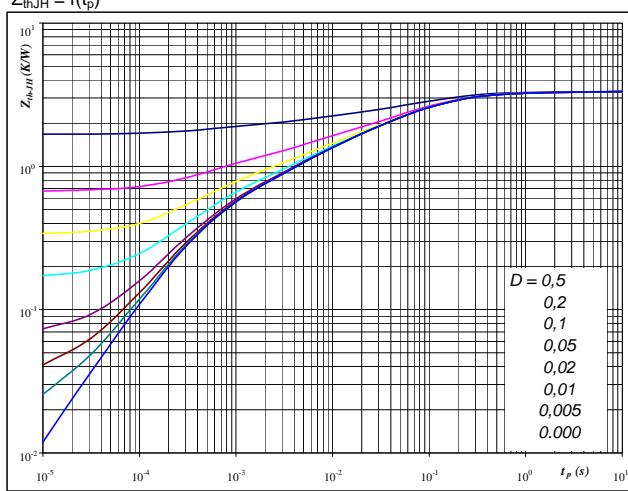

**At**

$D = t_p / T$   
 $R_{thJH} = 2,41$  K/W

**Output inverter IGBT**
**Figure 20**

FWD transient thermal impedance  
as a function of pulse width

$$Z_{thJH} = f(t_p)$$


**At**

$D = t_p / T$   
 $R_{thJH} = 3,33$  K/W

**FWD thermal model values**

Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,06	5,2E+00	0,05	4,2E+00
0,26	5,0E-01	0,21	4,1E-01
0,97	1,0E-01	0,78	8,1E-02
0,52	1,9E-02	0,42	1,5E-02
0,35	3,4E-03	0,28	2,8E-03
0,26	3,5E-04	0,21	2,8E-04

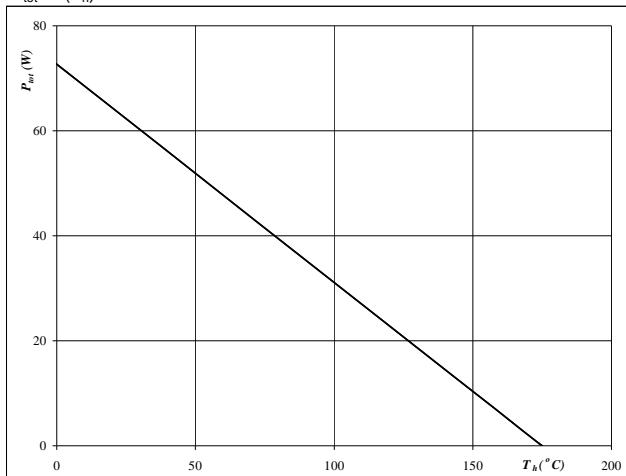
Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,07	8,2E+00	0,05	6,6E+00
0,31	5,2E-01	0,25	4,3E-01
1,25	9,3E-02	1,01	7,6E-02
0,78	2,0E-02	0,63	1,6E-02
0,54	3,2E-03	0,43	2,6E-03
0,40	4,1E-04	0,33	3,3E-04

## Output Inverter

**Figure 21**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

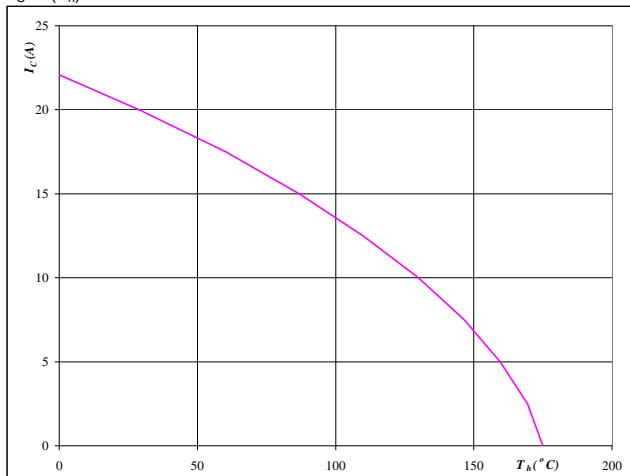

**At**

$$T_j = 175 \quad ^\circ\text{C}$$

**Output inverter IGBT**
**Figure 22**

**Collector current as a function of heatsink temperature**

$$I_C = f(T_h)$$


**At**

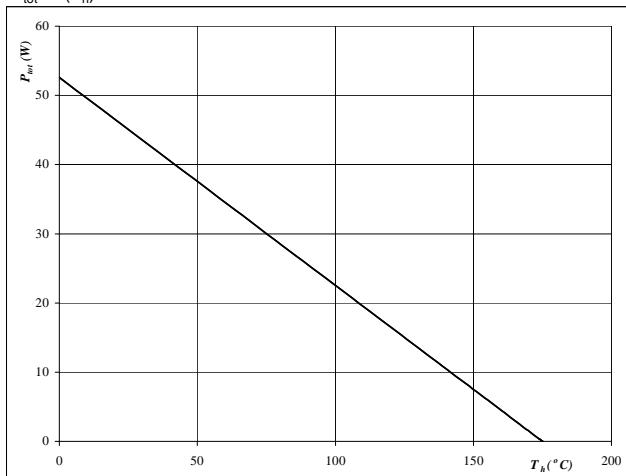
$$T_j = 175 \quad ^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

**Figure 23**
**Output inverter FWD**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

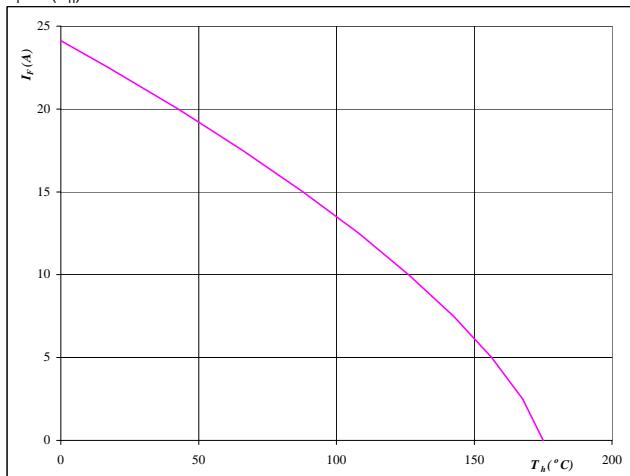

**At**

$$T_j = 175 \quad ^\circ\text{C}$$

**Figure 24**
**Output inverter FWD**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$


**At**

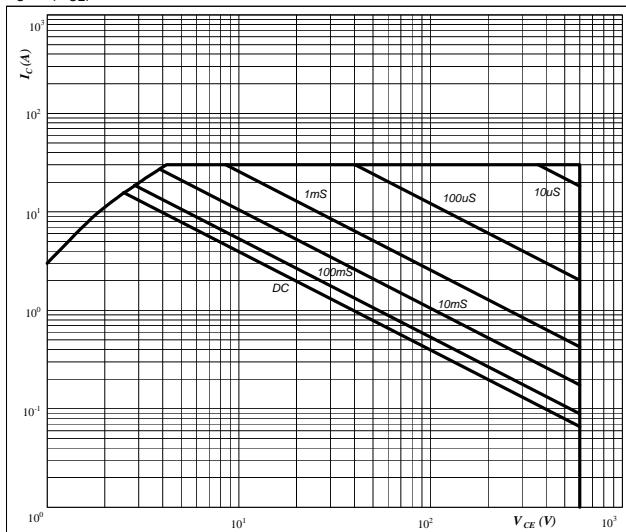
$$T_j = 175 \quad ^\circ\text{C}$$

## Output Inverter

**Figure 25**

**Safe operating area as a function of collector-emitter voltage**

$$I_C = f(V_{CE})$$


**At**

D = single pulse

T<sub>h</sub> = 80 °C

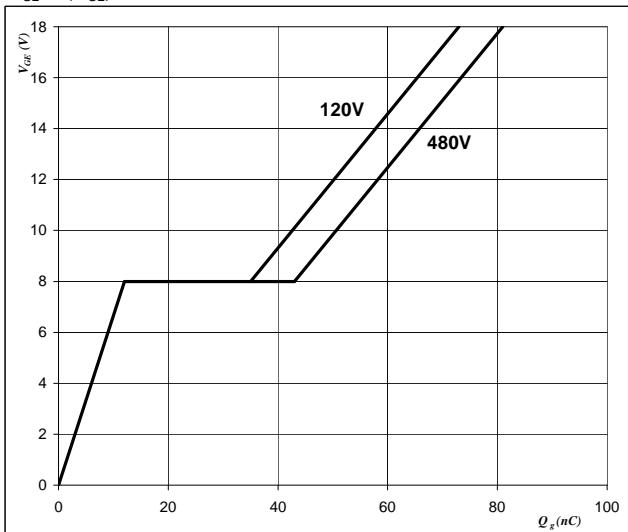
V<sub>GE</sub> = 15 V

T<sub>j</sub> = T<sub>jmax</sub> °C

**Output inverter IGBT**
**Figure 26**

**Gate voltage vs Gate charge**

$$V_{GE} = f(Q_{GE})$$

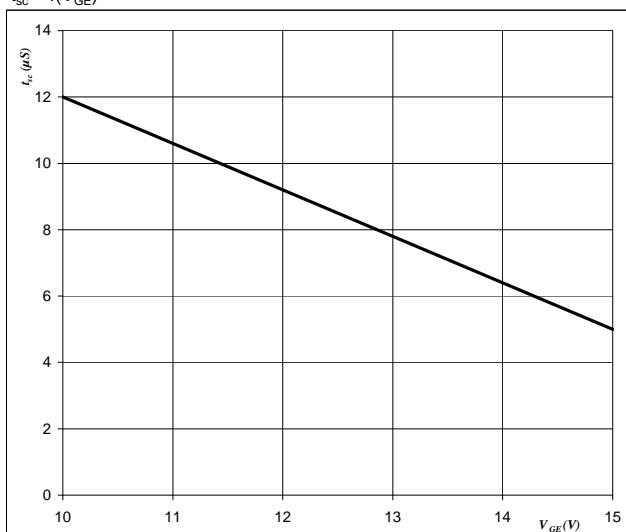

**At**

I<sub>C</sub> = 10 A

**Figure 27**

**Short circuit withstand time as a function of gate-emitter voltage**

$$t_{sc} = f(V_{GE})$$


**At**

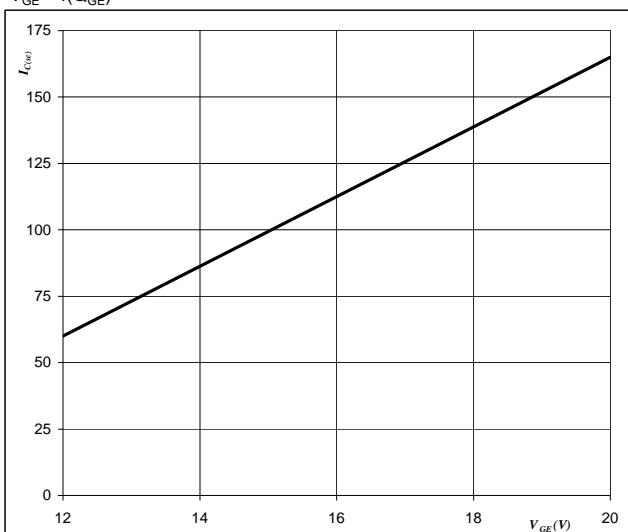
V<sub>CE</sub> = 600 V

T<sub>j</sub> ≤ 175 °C

**Output inverter IGBT**
**Figure 28**

**Typical short circuit collector current as a function of gate-emitter voltage**

$$V_{GE} = f(Q_{GE})$$

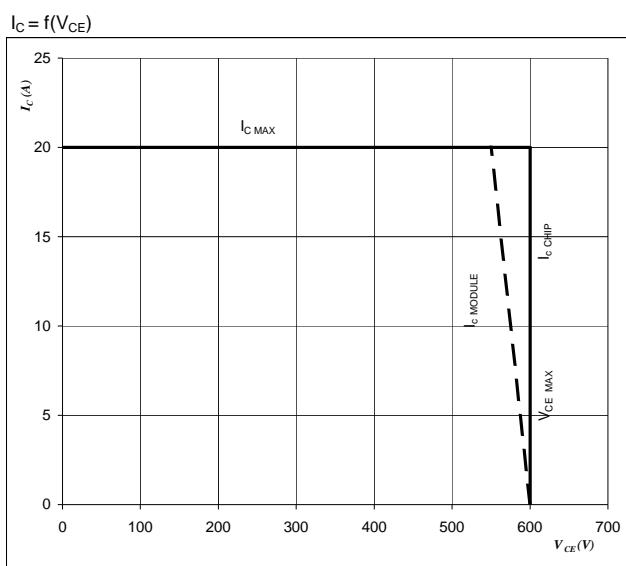

**At**

V<sub>CE</sub> ≤ 600 V

T<sub>j</sub> = 175 °C

**Figure 29**  
**Reverse bias safe operating area**

IGBT



At

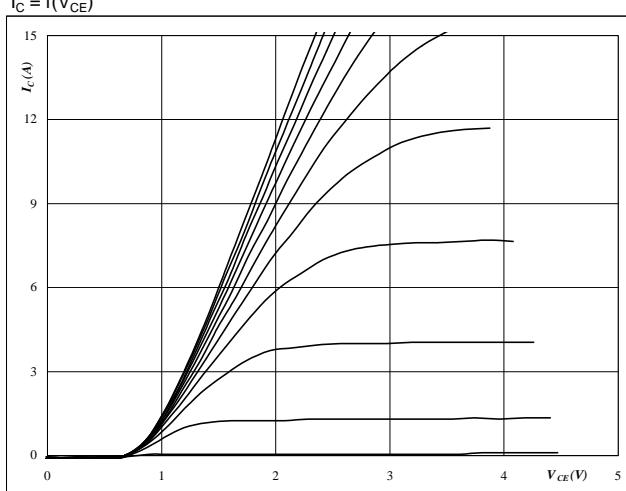
$$T_j = T_{j\max} - 25 \quad ^\circ\text{C}$$

$$U_{ccminus} = U_{ccplus}$$

Switching mode : 3 level switching

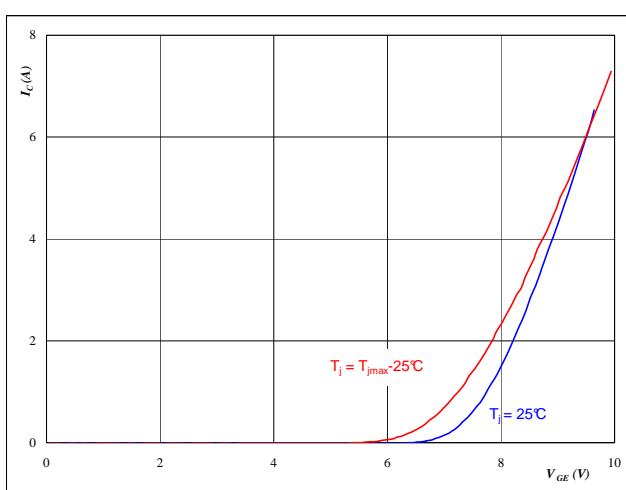
## Brake

**Figure 1**  
**Typical output characteristics**  
 $I_C = f(V_{CE})$



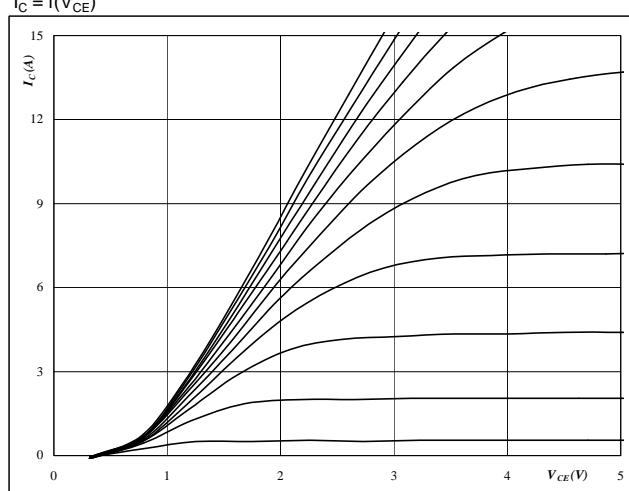
**At**  
 $t_p = 250 \mu s$   
 $T_j = 25^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3**  
**Typical transfer characteristics**  
 $I_C = f(V_{GE})$



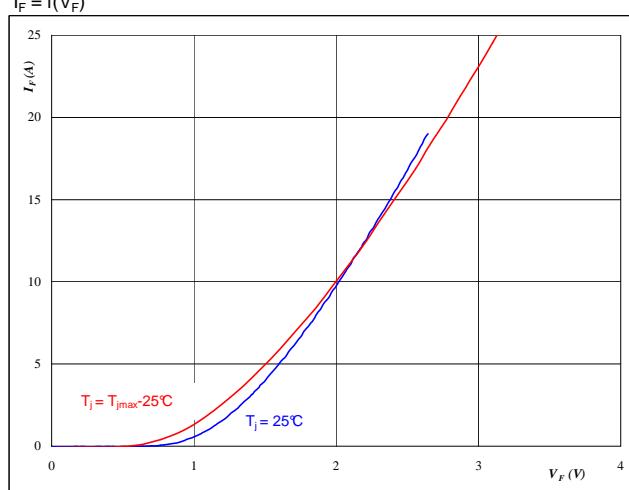
**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**Figure 2**  
**Typical output characteristics**  
 $I_C = f(V_{CE})$



**At**  
 $t_p = 250 \mu s$   
 $T_j = 125^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 4**  
**Typical diode forward current as a function of forward voltage**  
 $I_F = f(V_F)$



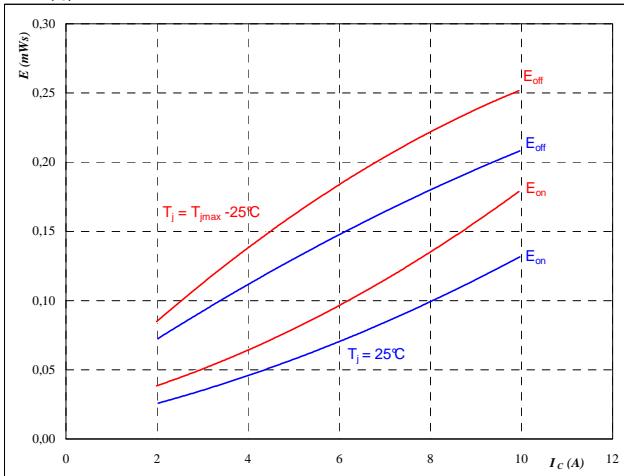
**At**  
 $t_p = 250 \mu s$

## Brake

**Figure 5**

**Typical switching energy losses  
as a function of collector current**

$$E = f(I_C)$$



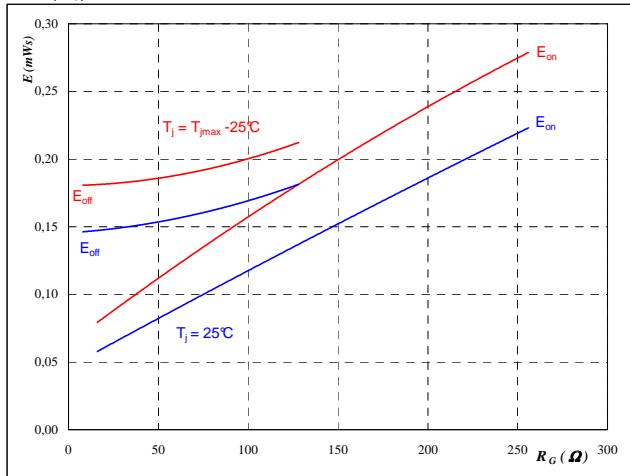
With an inductive load at

T <sub>j</sub> =	25/125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	15	V
R <sub>gon</sub> =	32	Ω
R <sub>goff</sub> =	16	Ω

**Brake IGBT**
**Figure 6**

**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



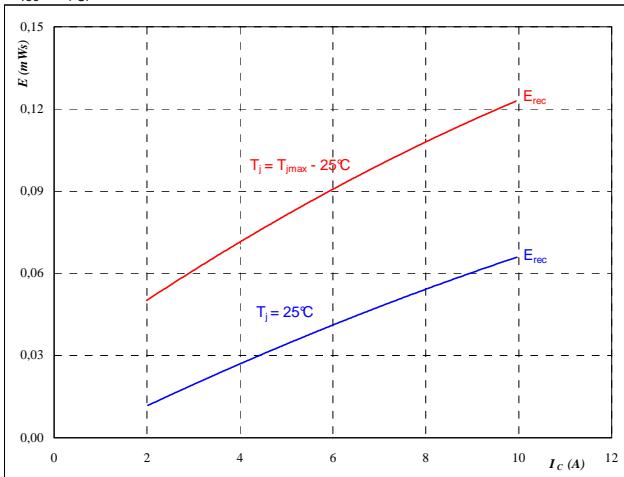
With an inductive load at

T <sub>j</sub> =	25/125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	15	V
I <sub>C</sub> =	6	A

**Figure 7**

**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_C)$$



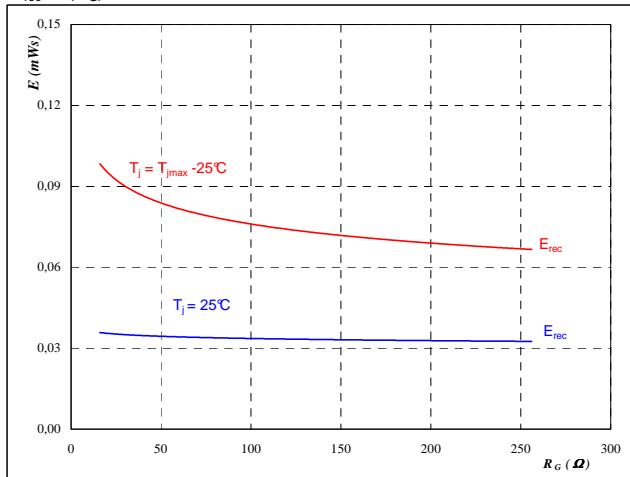
With an inductive load at

T <sub>j</sub> =	25/125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	15	V
R <sub>gon</sub> =	32	Ω

**Brake FWD**
**Figure 8**

**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

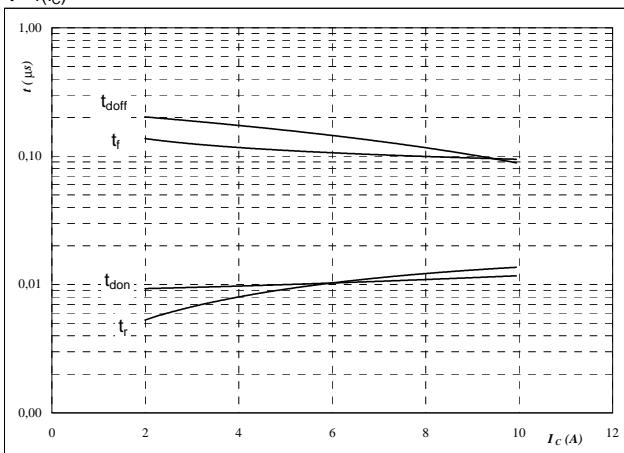
T <sub>j</sub> =	25/125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	15	V
I <sub>C</sub> =	6	A

## Brake

**Figure 9**

**Typical switching times as a function of collector current**

$$t = f(I_C)$$



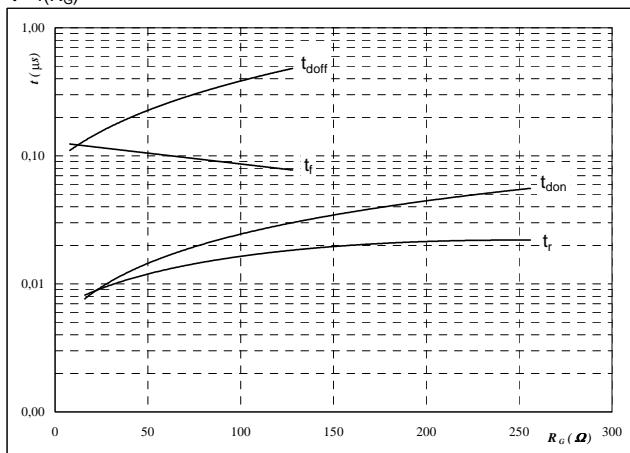
With an inductive load at

T <sub>j</sub> =	125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	15	V
R <sub>gon</sub> =	32	Ω
R <sub>goff</sub> =	16	Ω

**Brake IGBT**
**Figure 10**

**Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



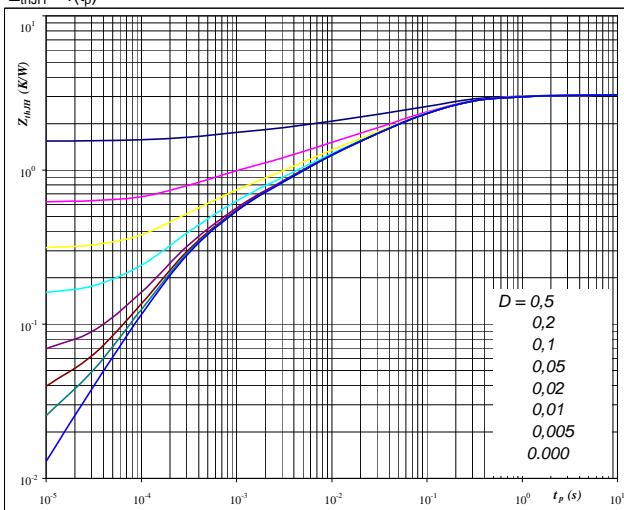
With an inductive load at

T <sub>j</sub> =	125	°C
V <sub>CE</sub> =	300	V
V <sub>GE</sub> =	15	V
I <sub>C</sub> =	6	A

**Figure 11**

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{thJH} = f(t_p)$$

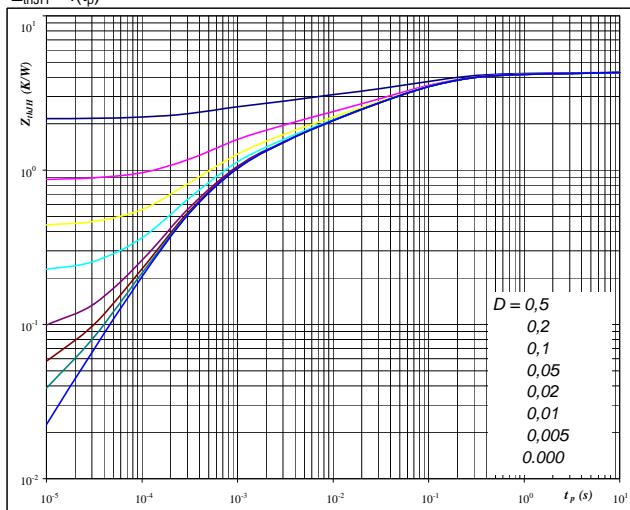


**At** Thermal grease      **D =** tp / T      **Phase change interface**  
 $R_{thJH} = 3,068 \text{ K/W}$        $R_{thJH} = 0,60 \text{ K/W}$

**Brake IGBT**
**Figure 12**

**FWD transient thermal impedance as a function of pulse width**

$$Z_{thJH} = f(t_p)$$



**At** Thermal grease      **D =** tp / T      **Phase change interface**  
 $R_{thJH} = 4,29 \text{ K/W}$        $R_{thJH} = 1,27 \text{ K/W}$

## Brake

**Figure 13**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

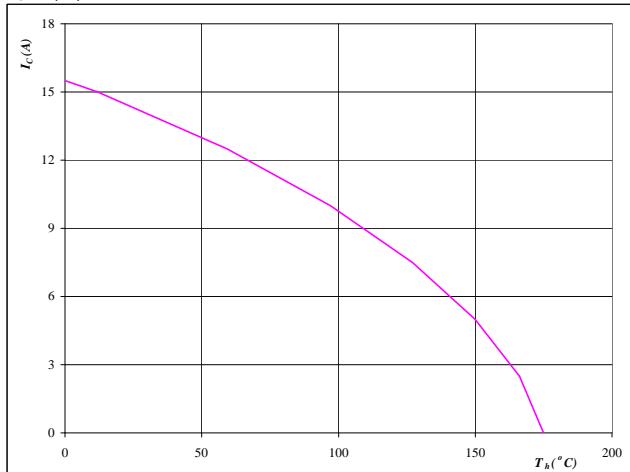

**At**

$$T_j = 175 \quad {}^\circ\text{C}$$

**Brake IGBT**
**Figure 14**

**Collector current as a function of heatsink temperature**

$$I_C = f(T_h)$$


**At**

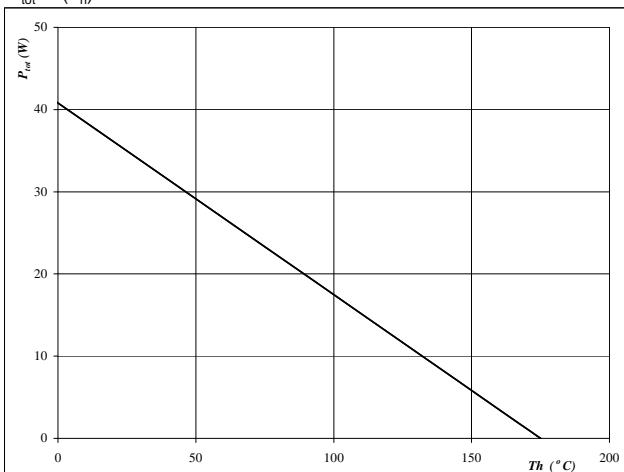
$$T_j = 175 \quad {}^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

**Figure 15**

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

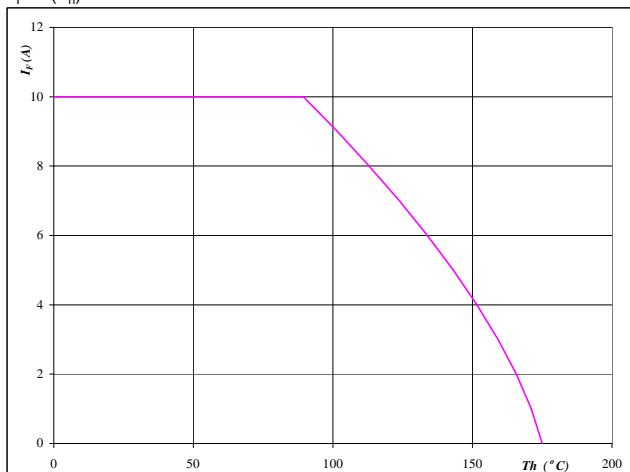

**At**

$$T_j = 175 \quad {}^\circ\text{C}$$

**Brake FWD**
**Figure 16**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$


**At**

$$T_j = 175 \quad {}^\circ\text{C}$$

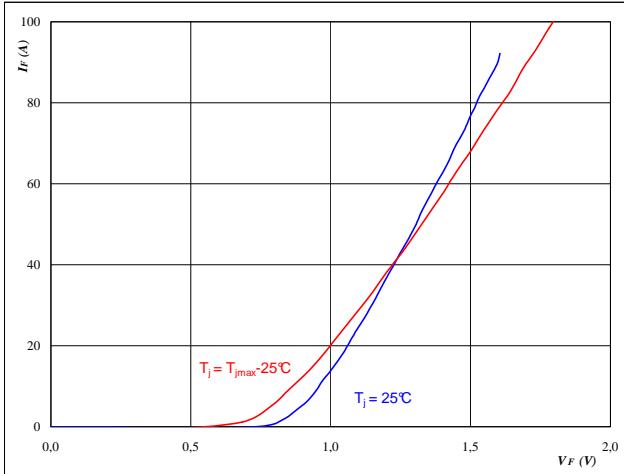
## Input Rectifier Bridge

**Figure 1**

Rectifier diode

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$


**At**

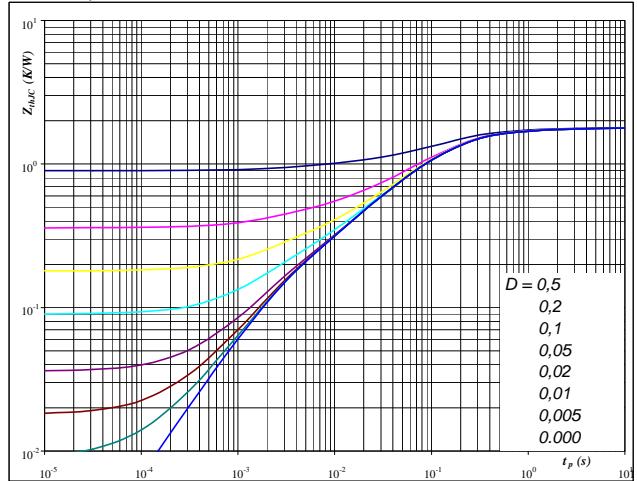
$$t_p = 250 \mu s$$

**Figure 2**

Rectifier diode

Diode transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$


**At**

$$D = t_p / T$$

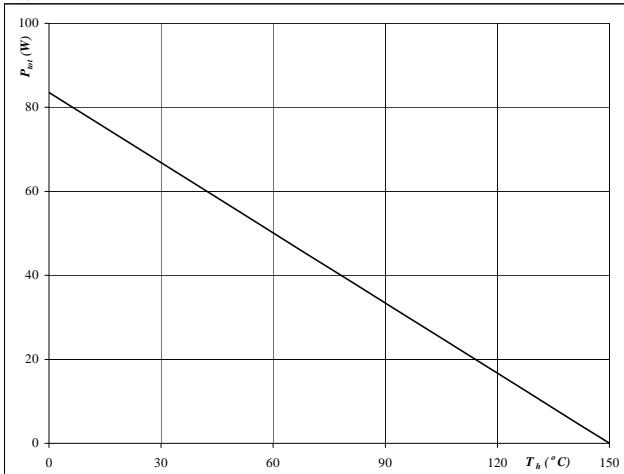
$$R_{thJH} = 1.89 \text{ K/W}$$

**Figure 3**

Rectifier diode

Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$


**At**

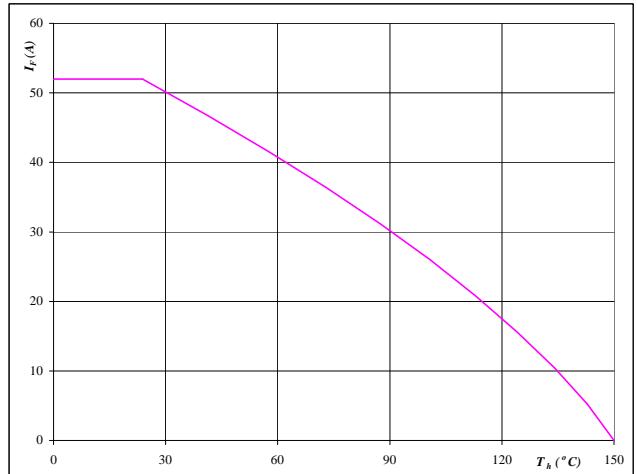
$$T_j = 150 {}^\circ C$$

**Figure 4**

Rectifier diode

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$


**At**

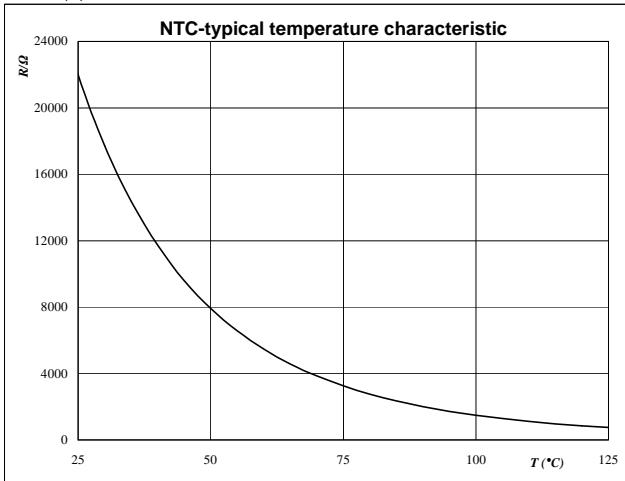
$$T_j = 150 {}^\circ C$$

## Thermistor

**Figure 1**

**Typical NTC characteristic  
as a function of temperature**

$$R_T = f(T)$$


**Thermistor**
**Figure 2**

**Typical NTC resistance values**

$$R(T) = R_{25} \cdot e^{\left( B_{25/100} \left( \frac{1}{T} - \frac{1}{T_{25}} \right) \right)} \quad [\Omega]$$

T [°C]	R <sub>nom</sub> [Ω]	R <sub>min</sub> [Ω]	R <sub>max</sub> [Ω]	△R/R [±%]
-55	2089434,5	1506495,4	2672373,6	27,9
0	71804,2	59724,4	83884	16,8
10	43780,4	37094,4	50466,5	15,3
20	27484,6	23684,6	31284,7	13,8
25	22000	19109,3	24890,7	13,1
30	17723,3	15512,2	19934,4	12,5
60	5467,9	4980,6	5955,1	8,9
70	3848,6	3546	4151,1	7,9
80	2757,7	2568,2	2947,1	6,9
90	2008,9	1889,7	2128,2	5,9
<b>100</b>	<b>1486,1</b>	<b>1411,8</b>	<b>1560,4</b>	<b>5</b>
150	400,2	364,8	435,7	8,8

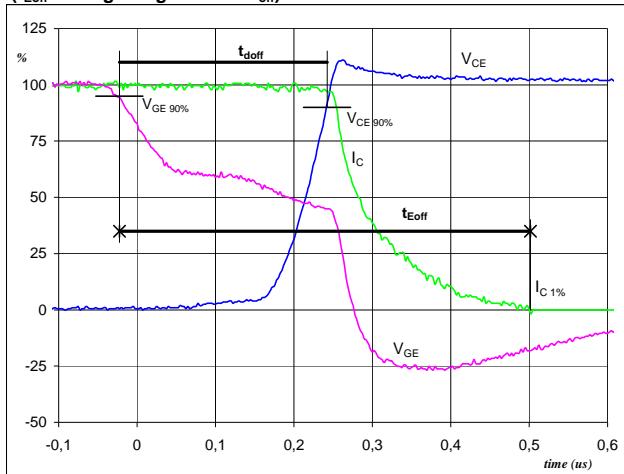
## Switching Definitions Output Inverter

**General conditions**

$T_j$	= 125 °C
$R_{gon}$	= 32 Ω
$R_{goff}$	= 16 Ω

**Figure 1**

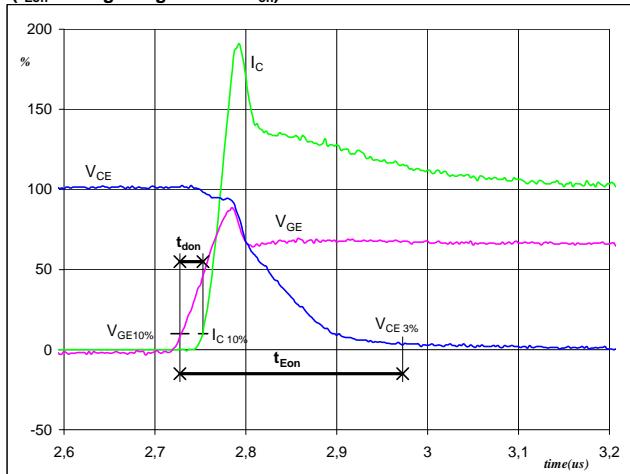
Output inverter IGBT  
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$   
( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%) = 0 \text{ V}$   
 $V_{GE}(100\%) = 15 \text{ V}$   
 $V_C(100\%) = 300 \text{ V}$   
 $I_C(100\%) = 10 \text{ A}$   
 $t_{doff} = 0,26 \mu\text{s}$   
 $t_{Eoff} = 0,52 \mu\text{s}$

**Figure 2**

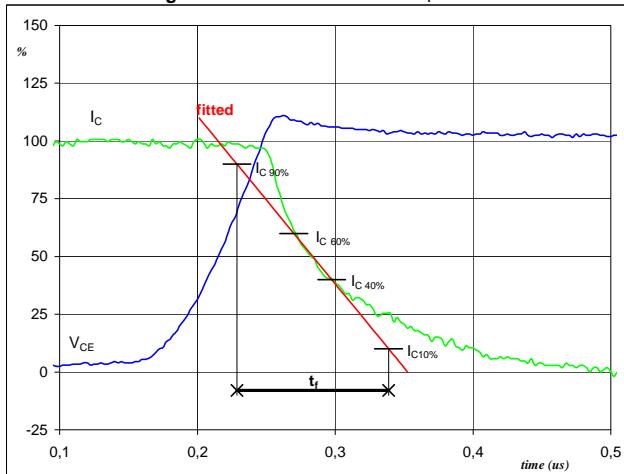
Output inverter IGBT  
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$   
( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%) = 0 \text{ V}$   
 $V_{GE}(100\%) = 15 \text{ V}$   
 $V_C(100\%) = 300 \text{ V}$   
 $I_C(100\%) = 10 \text{ A}$   
 $t_{don} = 0,02 \mu\text{s}$   
 $t_{Eon} = 0,24 \mu\text{s}$

**Figure 3**

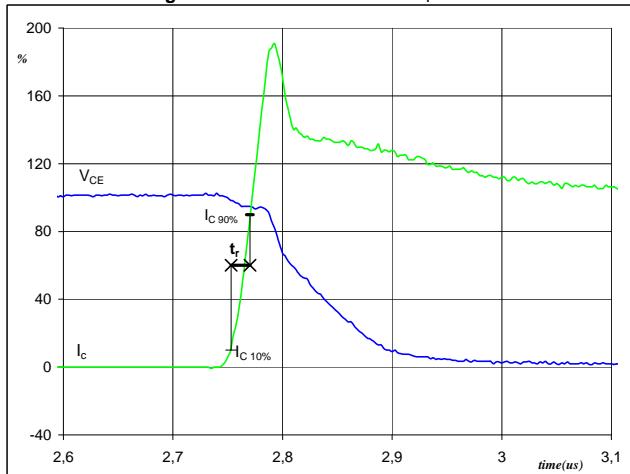
Output inverter IGBT  
Turn-off Switching Waveforms & definition of  $t_f$



$V_C(100\%) = 300 \text{ V}$   
 $I_C(100\%) = 10 \text{ A}$   
 $t_f = 0,10 \mu\text{s}$

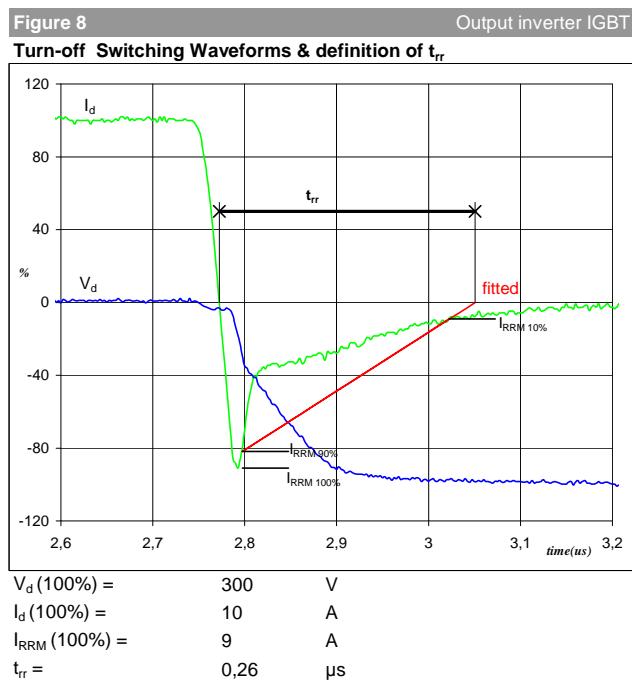
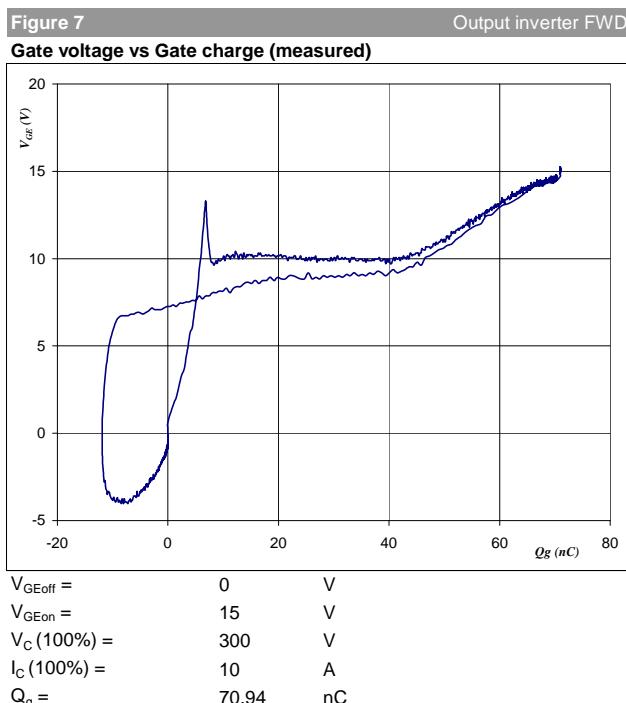
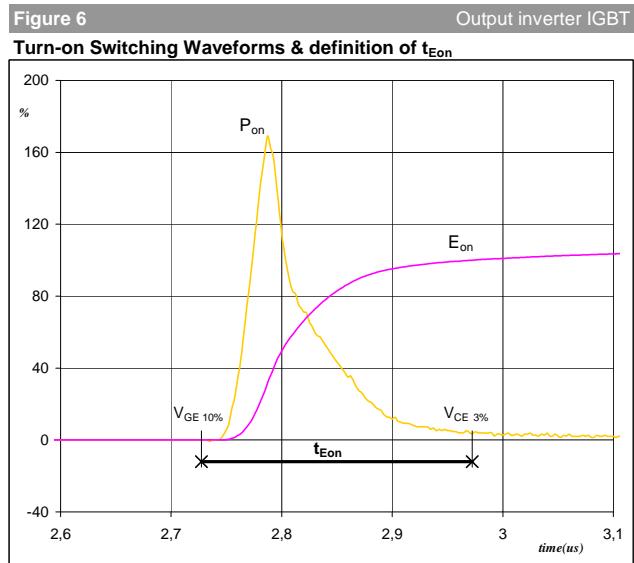
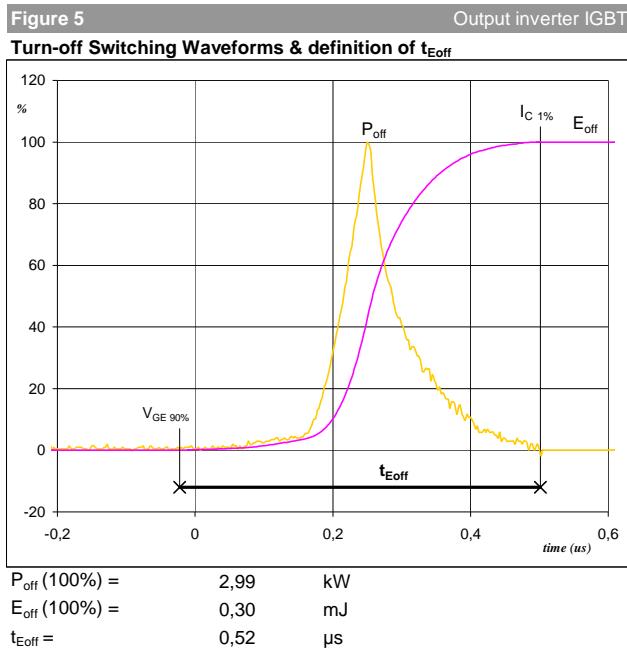
**Figure 4**

Output inverter IGBT  
Turn-on Switching Waveforms & definition of  $t_f$



$V_C(100\%) = 300 \text{ V}$   
 $I_C(100\%) = 10 \text{ A}$   
 $t_f = 0,02 \mu\text{s}$

## Switching Definitions Output Inverter

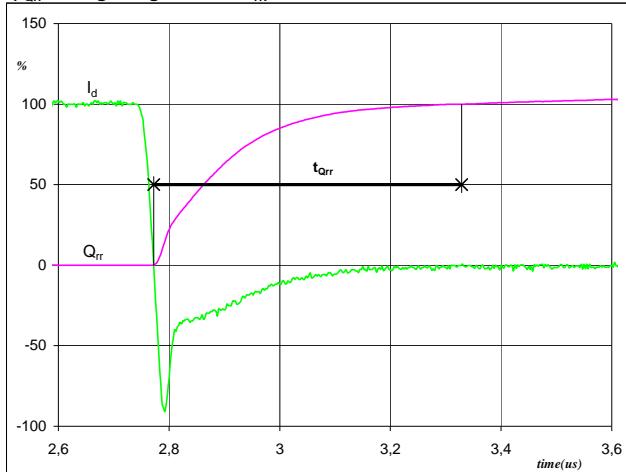


## Switching Definitions Output Inverter

**Figure 9**

Output inverter FWD

**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$

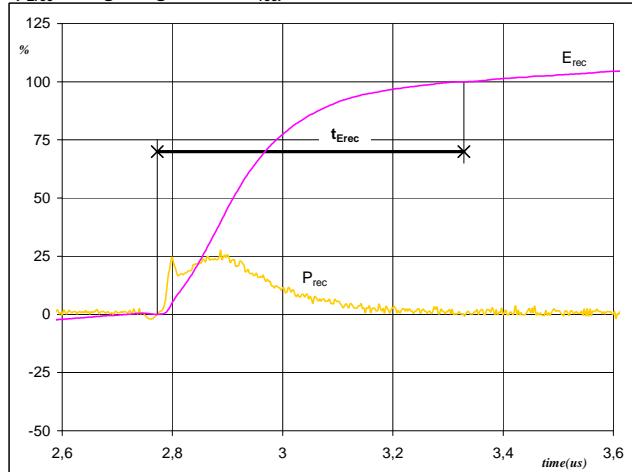


$I_d(100\%) = 10 \text{ A}$   
 $Q_{rr}(100\%) = 0,82 \mu\text{C}$   
 $t_{Qrr} = 0,56 \mu\text{s}$

**Figure 10**

Output inverter FWD

**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
 $(t_{Erec} = \text{integrating time for } E_{rec})$



$P_{rec}(100\%) = 2,99 \text{ kW}$   
 $E_{rec}(100\%) = 0,16 \text{ mJ}$   
 $t_{Erec} = 0,56 \mu\text{s}$

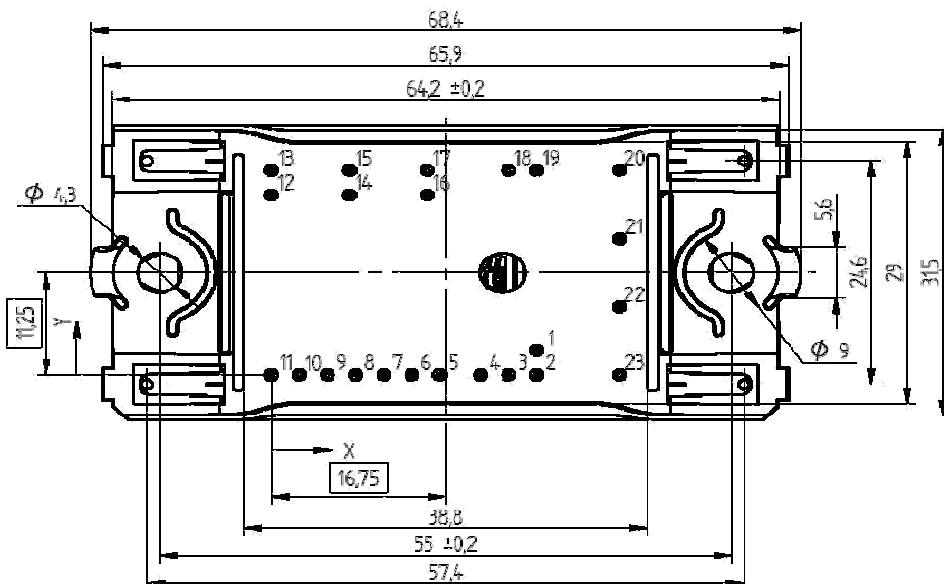
### Ordering Code and Marking - Features - Outline - Pinout

#### Ordering Code & Marking

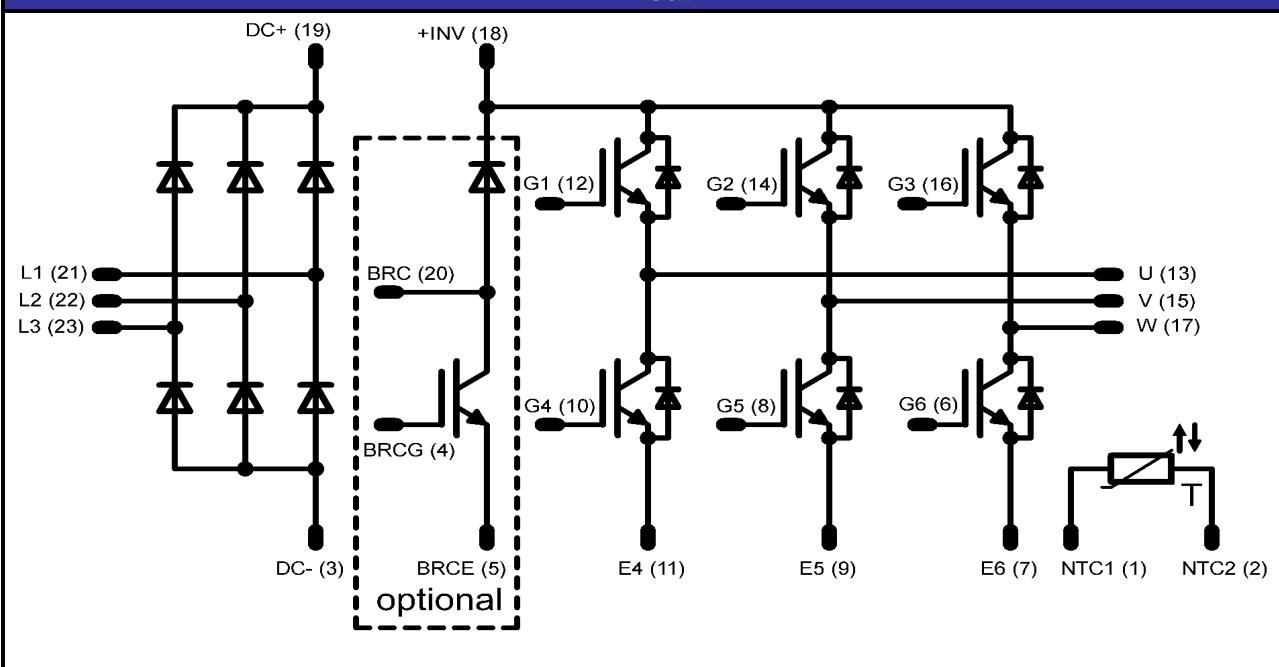
Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	V23990-P543-A38-PM	P543-A38	P543-A38
without thermal paste, w/o brake, 12mm housing	V23990-P543-C38-PM	P543-C38	P543-C38
without thermal paste, w/o brake, 17mm housing	V23990-P543-C39-PM	P543-C39	P543-C39

#### Outline

Pin Table		
Pin	X	Y
1	25,5	2,7
2	25,5	0
3	22,8	0
4	20,1	0
5	16,2	0
6	13,5	0
7	10,8	0
8	8,1	0
9	5,4	0
10	2,7	0
11	0	0
12	0	19,8
13	0	22,5
14	7,5	19,8
15	7,5	22,5
16	15	19,8
17	15	22,5
18	22,8	22,5
19	25,5	22,5
20	33,5	22,5
21	33,5	15
22	33,5	7,5
23	33,5	0



#### Pinout



**DISCLAIMER**

The information given in this datasheet describes the type of component and does not represent assured characteristics. For tested values please contact Vincotech. Vincotech reserves the right to make changes without further notice to any products herein to improve reliability, function or design. Vincotech does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

**LIFE SUPPORT POLICY**

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.